

## FAST SWITCHING DIODES

### FEATURES

Silicon epitaxial planar diode

High speed switching diode

500 mW power dissipation

These diodes are also available in glass case DO-34. Mini-MELF

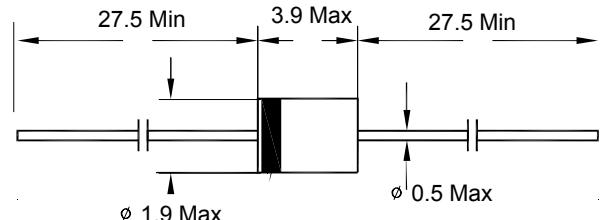
### MECHANICAL DATA

Weight: 0.004 ounces, 0.13 grams

Case: DO-35, glass case

Polarity: Color band denotes cathode

### 1N4148



DO-35 Dimensions in millimeters

### Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Reverse voltage	V <sub>R</sub>	75	v
Peak reverse voltage	V <sub>RM</sub>	100	v
Average Rectified Current	I <sub>O</sub>	150	mA
Non-repetitive Peak Forward Current	I <sub>FSM</sub>	500 <sup>1)</sup>	mA
Power dissipation at Tamb=25°C	P <sub>tot</sub>	500	mW
Junction temperature	T <sub>J</sub>	175	°C
Storage temperature range	T <sub>STG</sub>	-55-175	°C

1)Valid provided that leads at a distance of 8 mm from case are kept at ambient temperature.

### ELECTRICAL CHARACTERISTICS (Tamb=25 °C unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit
Forward voltage @ IF=10mA	V <sub>F</sub>			1.0	v
Leakage current at V <sub>R</sub> =20V	I <sub>R</sub>			25	nA
at V <sub>R</sub> =75V	I <sub>R</sub>			5	uA
at V <sub>R</sub> =20V T <sub>J</sub> =150°C	I <sub>R</sub>			50	uA
Capacitance at V <sub>F</sub> =V <sub>R</sub> =0V	C <sub>tot</sub>			4	pF
Voltage rise when switching on tested with 50mA pulses tp=0,1uS , rise time<30ns, f p=5 to 100KHz	V <sub>fr</sub>			2.5	v
Reverse recovery time from I <sub>F</sub> =10mA VR=6V,RL=100 ,at IR=1mA	trr			4.0	nS
Thermal resistance junction to ambient	R <sub>JA</sub>			350	K/W
Rectification efficiency at 100MHz, V <sub>RF</sub> =2V	η V	0.45			

**1N4148 Typical Characteristics**


AMBIENT TEMPERATURE

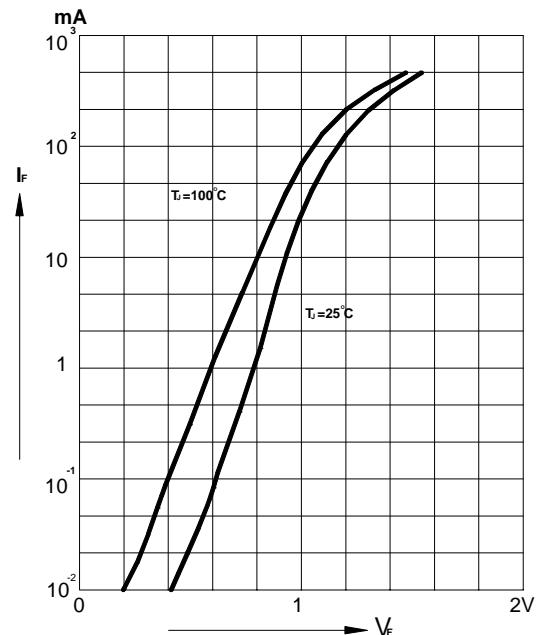


FIG.2- FORWARD CHARACTERISTICS

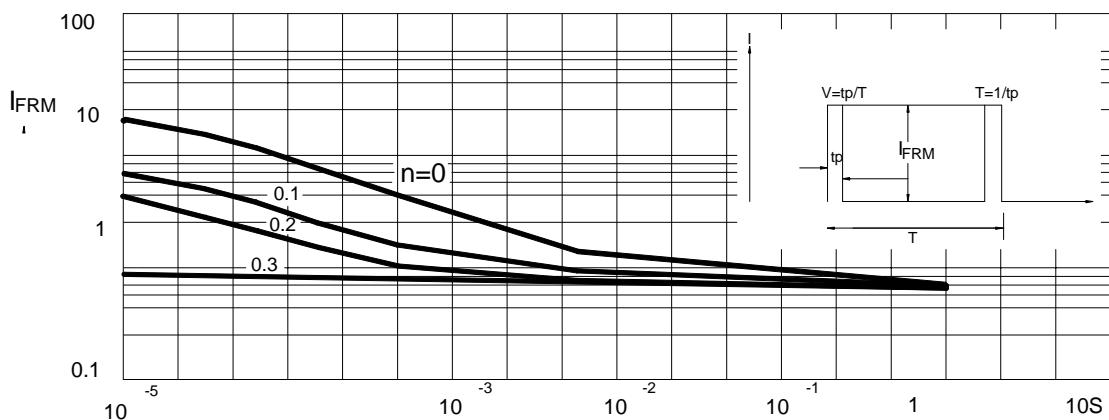


FIG.3-ADMISSIBLE REPETITIVE PEAK FORWARD CURRENT VERSUS PULSE DURATION